

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Ligang Zhang et al.
Title: REDISTRIBUTION LAYER SHIELDING OF A CIRCUIT ELEMENT
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Examiner: Colleen A. Matthews Group Art Unit: 2821
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RESPONSE AFTER FINAL REJECTION (37 C.F.R. § 1.116)

This paper is being submitted following the Final Rejection mailed on September 11, 2007. In light of the Amendments and/or Remarks herein, further consideration is requested.

Any fees required by this paper are being provided as directed in an electronic submission of this paper or in a transmittal letter accompanying this paper. However, the Commissioner is hereby authorized to charge any deficiency in fees required by this paper and any additional fees under 37 C.F.R. § 1.16 or 1.17 which may be required during the pendency of this application, and to similarly credit any overpayment, to Deposit Account 50-0631.